



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application of: John Commander, et al. Art Unit: 1753
Serial No.: 10/091,106
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Confirmation No.: 5919
For: DEFECT REDUCTION IN ELECTRODEPOSITED
COPPER FOR SEMICONDUCTOR APPLICATIONS
Examiner: Edna Wong

December 18, 2006

AMENDMENT H

In response to the Office action dated June 16, 2006,
please consider the following amendments and remarks.

Amendments to the claims are reflected in the listing of
the claims that begins on page 2 of this paper.

Remarks begin on page 7 of this paper.

Conclusion begins on page 14 of this paper.